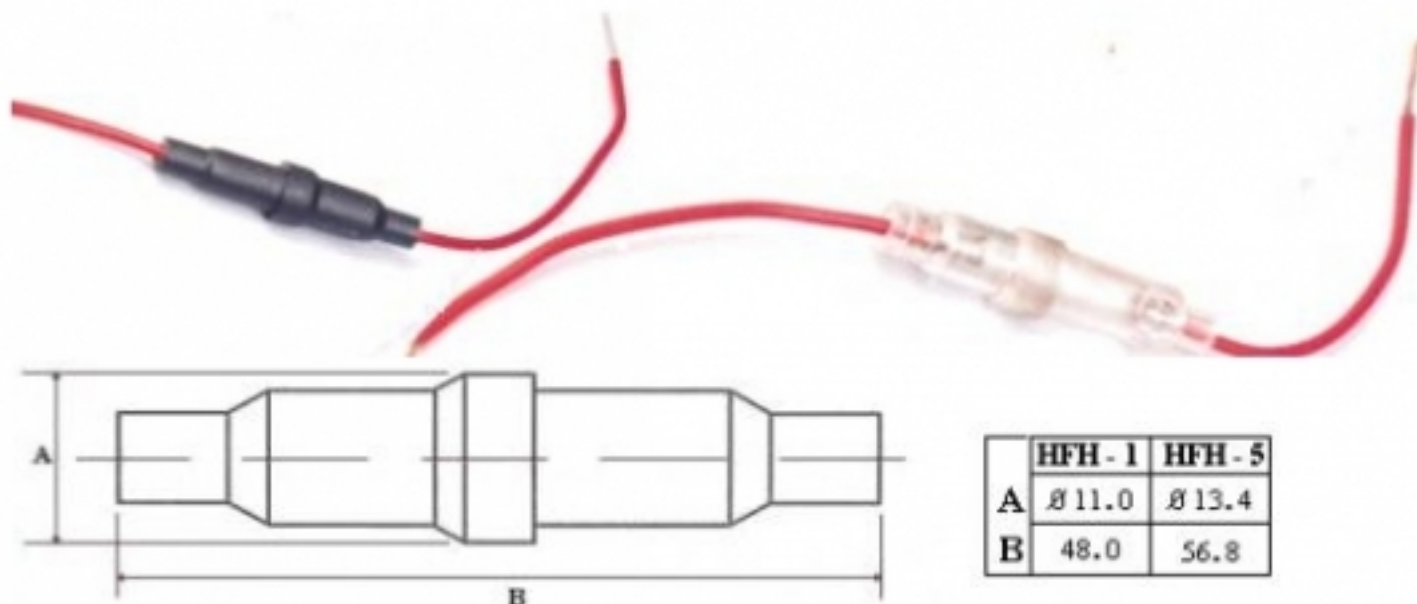




Specifications

Mounting Style:	In-line (Hanging)
Terminals:	Solder-type
Permissible Temp. With / Without load:	-20 deg C to +85 Deg. C
Permissible Temp. For Soldering:	270 Deg. C for 5 seconds max.
Panel Thickness(Max):	N.A.
Material:	Polyamide G.F. / Polycarbonate
Insulation Resistance at 500VDC:	1000 M ohm
H. V. Break Down for 1 minute:	2 KVAC.
Current Carrying Parts:	Copper Alloy, Tin Plated
Contact Resistance (Initial):	20 m Ohms max.
Cap Design:	NA
Fuse Link Size:	5 x 20 mm
Rated Current / Voltage:	4 Amps, 250V AC

Elcom International Pvt. Ltd.

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